



HRQ Series RF High Q Multilayer Chip Ceramic Capacitor

1. Capacitor characteristics and applications

1.1 Characteristics

- Size specifications are standardized and suitable for surface mount components in hybrid integrated circuits or printed circuits;
- High Q value, ultra low ESR, high reliability;
- Low loss, high capacitance stability, high operating frequency;
- Suitable for high-frequency circuits, VHF-microwave bands, RF and amplification circuits in various equipment;



1.2 Main performance indicators

- Temperature coefficient: C0G: $0 \pm 30 \text{ ppm}/^\circ\text{C}$
- Capacitance drift: no more than $\pm 0.2\%$ or $\pm 0.05 \text{ pF}$, whichever is larger.
- Quality factor (Q value): greater than 2,000 at a frequency of 1mHz/1kHz
- Insulation resistance: $\geq 100000 \text{ m}\Omega$ at 20°C
- Operating temperature: $-55 \sim 125^\circ\text{C}$

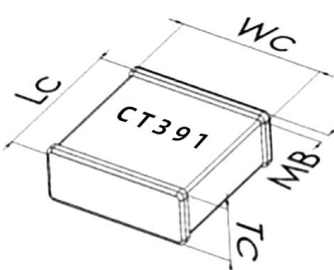
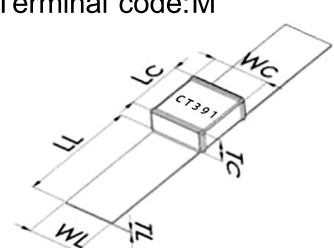
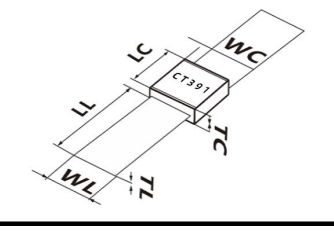
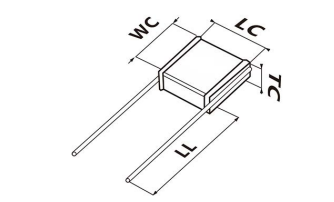
2. Product model naming

How to order

<u>HRQ</u>	<u>1111</u>	<u>C0G</u>	<u>1R0</u>	<u>B</u>	<u>501</u>	<u>N</u>	<u>T</u>
Product series	Size specifications	Type of Dielectric	Capacitance (unit: pF)	Tolerance	Rated voltage	Termination	Packaging form
HRQ series RF high Q capacitor	0402 1111 0603 2525 3838 0805 0505 0709	C0G: +30ppm/°C	The first two digits are significant figures, and the last digit is the power of 10	A : $\pm 0.05 \text{ pF}$ B : $\pm 0.10 \text{ pF}$ C : $\pm 0.25 \text{ pF}$ D : $\pm 0.50 \text{ pF}$ F : $\pm 1.0\%$ G : $\pm 2.0\%$ J : $\pm 5.0\%$ K : $\pm 10.0\%$	The first two digits are significant figures, and the last digit is the power of 10	N: Leading-out Terminal: Ag/Ni/Sn Z: Leading-out Terminal: Ag/Ni/SnPb E: Non-magnetic Terminal M: MMicrostrip A: Axial tape RW: Radial wire RN: Non-magnetic radial wire	T: Tape & reel C: Cut Tray B: Bulk



3. Product dimension

Product type	Size specifications Inch	Capacitor size(mm)			Terminal size(mm)			
		Lc	Wc	Tc max	MB	L _L min	W _L	T _L
Terminal code:N \ Z \ E 	0402	1.00±0.20	0.50±0.20	0.55	0.25±0.10	—		
	0603	1.52±0.25	0.76±0.25	1.01	0.30±0.15			
	0805	2.00±0.25	1.25±0.25	1.45	0.50±0.20			
	0505	1.40 -0.25~+0.38	1.40±0.38	1.45	0.40±0.15			
	0709	1.78±0.25	2.29±0.25	2.92	0.50±0.20			
	1111	2.79 -0.25~+0.51	2.79±0.38	2.59	0.60±0.20			
	2525	5.84 -0.25~+0.51	6.35±0.38	3.68	0.80±0.30			
	3838	9.65 -0.25~+0.38	9.65±0.25	5.00	1.00±0.50			
Terminal code:M 	1111	3.50±0.38	2.79±0.25	2.54	—	6.35	2.36±0.13	0.20±0.05
	2525	6.35±0.38	6.35±0.38	3.68		12.70	6.10±0.13	0.20±0.05
	3838	9.65 -0.25~+0.89	9.65±0.25	5.00		19.05	8.64±0.25	0.25±0.10
Terminal code:A 	2525	6.35±0.38	6.35±0.38	3.68		12.70	6.10±0.13	0.20±0.05
	3838	9.65 -0.25~+0.89	9.65±0.25	5.00		19.05	8.64±0.25	0.25±0.10
Terminal code: RW \ RN 	1111	3.90±0.51	2.79±0.38	2.59		12.70	Lead diameter 0.40±0.05	
	2525	5.84 -0.25~+1.91	6.35±0.38	3.68		25.40	Lead diameter 0.80±0.05	
	3838	9.65 -0.25~+2.16	9.65±0.25	5.00				



4 . Capacity range

4.1 0402 specification capacitance table

Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	
0R1 0R2 0R3 0R4	0.1 0.2 0.3 0.4	A, B, C.	250	2R1 2R2 2R4 2R7 3R0 3R3	2.1 2.2 2.4 2.7 3 3.3	B, C, D.	250	130 150 160 180 200 220	13 15 16 18 20 22	F, G, J.	200	
0R5 0R6 0R7 0R8 0R9 1R0 1R1 1R2 1R3 1R4 1R5 1R6 1R7 1R8 1R9 2R0	0.5 0.6 0.7 0.8 0.9 1 1.1 1.2 1.3 1.4 1.5 1.6 1.7 1.8 1.9 2	A, B, C, D.		3R6 3R9 4R3 4R7 5R1 5R6 6R2 6R8 7R5 8R2 9R1	3.6 3.9 4.3 4.7 5.1 5.6 6.2 6.8 7.5 8.2 9.1			200	240 270 300 330			24 27 30 33



4.2 0603 specification capacitance table

Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)
0R2	0.2	A, B, C.	250	3R3	3.3	B, C, D.	250	360	36	F, G, J, K, M.	250
0R3	0.3			3R6	3.6			390	39		
0R4	0.4			3R9	3.9			430	43		
				4R3	4.3			470	47		
0R5	0.5	A, B, C, D.		4R7	4.7			510	51		
0R6	0.6			5R1	5.1			560	56		
0R7	0.7			5R6	5.6			620	62		
0R8	0.8			6R2	6.2			680	68		
0R9	0.9			6R8	6.8			750	75		
1R0	1			7R5	7.5			820	82		
1R1	1.1			8R2	8.2			910	91		
1R2	1.2			9R1	9.1			101	100		
1R3	1.3			100	10	111		110			
1R4	1.4			110	11	121		120			
1R5	1.5			120	12	131		130			
1R6	1.6			130	13	151		150			
1R7	1.7			150	15						
1R8	1.8			160	16						
1R9	1.9			180	18						
2R0	2			200	20						
2R1	2.1			220	22						
2R2	2.2			240	24						
2R4	2.4			270	27						
2R7	2.7			300	30						
3R0	3	330		33							



4.3 0505 specification capacitance table

Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)		
0R2	0.2	B, C.	250	3R6	3.6		250	390	39	F, G, J, K, M.	300		
0R3	0.3			3R9	3.9			430	43				
0R4	0.4			4R3	4.3			470	47				
0R5	0.5	B, C, D.		250	4R7	4.7		250	510		51	F, G, J, K, M.	250
0R6	0.6				5R1	5.1			560		56		
0R7	0.7				5R6	5.6			620		62		
0R8	0.8				6R2	6.2			680		68		
0R9	0.9				6R8	6.8			750		75		
1R0	1				7R5	7.5			820		82		
1R1	1.1				8R2	8.2			910		91		
1R2	1.2		9R1		9.1	101	100						
1R3	1.3		100		10	111	110						
1R4	1.4		110		11	121	120						
1R5	1.5		120	12	131	130							
1R6	1.6		130	13	151	150							
1R7	1.7		150	15	161	160							
1R8	1.8		160	16	181	180							
1R9	1.9		180	18	201	200							
2R0	2		200	20	221	220							
2R1	2.1		220	22	241	240							
2R2	2.2	240	24	271	270	200							
2R4	2.4	270	27	301	300								
2R7	2.7	300	30	331	330	150							
3R0	3	330	33	361	360								
3R3	3.3	360	36	391	390								

**4.4 0805 specification capacitance table**

Capac -itance code	Capac -itance (pF)	Tolerance	Max DC working voltage(V)	Capac -itance code	Capac -itance (pF)	Tolerance	Max DC working voltage(V)	Capac -itance code	Capac -itance (pF)	Tolerance	Max DC working voltage(V)
0R3	0.3	A, B, C.	250	3R9	3.9	B, C, D.	250	430	43	F, G, J, K.	250
0R4	0.4			4R3	4.3			470	47		
0R5	0.5	B, C, D.		4R7	4.7			510	51		
0R6	0.6			5R1	5.1			560	56		
0R7	0.7			5R6	5.6			620	62		
0R8	0.8			6R2	6.2			680	68		
0R9	0.9			6R8	6.8			750	75		
1R0	1			7R5	7.5			820	82		
1R1	1.1			8R2	8.2			910	91		
1R2	1.2			9R1	9.1			101	100		
1R3	1.3				111	110					
1R4	1.4				121	120					
1R5	1.5				131	130					
1R6	1.6				151	150					
1R7	1.7				161	160					
1R8	1.8				181	180					
1R9	1.9				201	200					
2R0	2				221	220					
2R1	2.1				241	240					
2R2	2.2				271	270					
2R4	2.2				301	300					
2R7	2.4				331	330					
3R0	2.7										
3R3	3				361	360		150			
3R6	3.3				391	390					
	3.6				431	430					

4.5 1111 specification capacitance table

Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)		
0R5	0.5	A, B, C, D.	1500	4R7	4.7	B, C, D.	1500	510	51	F, G, J, K.	1500	561	560	F, G, J, K.	600		
0R6	0.6			5R1	5.1			560	56			621	620				
0R7	0.7			5R6	5.6			620	62			681	680		500		
0R8	0.8			6R2	6.2			680	68			751	750				
0R9	0.9			6R8	6.8			750	75			821	820				
1R0	1			7R5	7.5			820	82			911	910				
1R1	1.1	B, C, D.		8R2	8.2	F, G, J, K.		1500	910		91	F, G, J, K.	1000	150			
1R2	1.2			9R1	9.1				101		100				112	1100	
1R3	1.3			100	10				111		110				122	1200	250
1R4	1.4			110	11				121		120				132	1300	
1R5	1.5			120	12				131		130				152	1500	
1R6	1.6			130	13				151		150				162	1600	
1R7	1.7			150	15				161		160				182	1800	
1R8	1.8			160	16				181		180						
1R9	1.9			180	18				201		200						
2R0	2			200	20				221		220						
2R1	2.1			220	22				241		240						
2R2	2.2			240	24				271		270						
2R4	2.4			270	27				301		300						
2R7	2.7			300	30				331		330						
3R0	3			330	33				361		360						
3R3	3.3			360	36				391		390						
3R6	3.6			390	39												
3R9	3.9			430	43				431		430						
4R3	4.3	470		47	471	470											
				511	510			600									



4.6 2525 specification capacitance table

Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)
1R0	1.0	B, C.	3600	7R5	7.5	B, C, D.	3600	820	82	F, G, J, K, M.	3600	911	910		1500
1R1	1.1			8R2	8.2			910	91			102	1000		
1R2	1.2			9R1	9.1			101	100			112	1100		
1R3	1.3							111	110			122	1200		
1R4	1.4	B, C, D.		110	11	121		120	132			1300	F, G, J, K, M.	1000	
1R5	1.5			120	12	131		130	152			1500			
1R6	1.6			130	13	151		150	162			1600			
1R7	1.7			150	15	161		160	182			1800			
1R8	1.8			160	16	181		180	202			2000			
1R9	1.9			180	18	201		200	222			2200			
2R0	2.0			200	20	221		220	242			2400			
2R1	2.1			220	22	241		240	272			2700		500	
2R2	2.2			240	24	271		270	302			3000			
2R4	2.4			270	27	301		300	332		3300				
2R7	2.7			300	30	331		330	362		3600				
3R0	3			330	33	361		360	392		3900				
3R3	3.3			360	36	391		390	432		4300	250			
3R6	3.6			390	39	431		430	472		4700				
3R9	3.9			430	43	471		470	512		5100				
4R3	4.3			470	47	511		510	562		5600				
4R7	4.7			510	51	561		560							
5R1	5.1	560		56	621	620									
5R6	5.6	620		62	681	680									
6R2	6.2	680		68	751	750									
6R8	6.8	750		75	821	820									



4.7 3838 specification capacitance table

Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)		
1R0	1.0	B, C.	7200	7R5	7.5	B, C, D.	7200	820	82	F, G, J, K, M.	7200	911	910	F, G, J, K, M.	2500		
1R1	1.1			8R2	8.2			910	91			102	1000				
1R2	1.2			9R1	9.1			101	100			112	1100				
1R3	1.3							111	110			122	1200				
1R4	1.4	B, C, D.		100	10				121			120	132		1300	1500	
1R5	1.5			110	11				131			130	152		1500		2000
1R6	1.6			120	12				151			150	162		1600		
1R7	1.7			130	13				161			160	182		1800		
1R8	1.8			150	15				181			180	202		2000		
1R9	1.9			160	16							222	2200				
2R0	2.0			180	18				201		200	242	2400		1000		
2R1	2.1			200	20				221		220	272	2700				
2R2	2.2			220	22				241		240	302	3000				
2R4	2.4			240	24				271		270	332	3300				
2R7	2.7			270	27				301		300	362	3600				
3R0	3			300	30				331		330	392	3900				
3R3	3.3			330	33				361		360	432	4300				
3R6	3.6			360	36				391		390	472	4700				
3R9	3.9			390	39				431		430	512	5100				
4R3	4.3			430	43				471		470	562	5600				
4R7	4.7			470	47				511		510					500	
5R1	4.7			510	51				561		560	622	6200				
5R6	5.1	560		56				621	620	682	6800						
6R2	5.6	620		62				681	680								
6R8	6.2			680	68			751	750	2500							
	6.8		750	75				821	820								



4.8 0709 specification capacitance table

Capac -itance code	Capac -itance (pF)	Tolerance	Max DC working voltage(V)	Capac -itance code	Capac -itance (pF)	Tolerance	Max DC working voltage(V)	Capac -itance code	Capac -itance (pF)	Tolerance	Max DC working voltage(V)
1R0	1	B, C, D.	500	6R2	6.2	B, C, D.	500	560	56	F, G, J.	500
1R1	1.1			6R8	6.8			620	62		
1R2	1.2			7R5	7.5			680	68		
1R3	1.3			8R2	8.2			750	75		
1R4	1.4			9R1	9.1			820	82		
1R5	1.5			100	10	F, G, J.		910	91		
1R6	1.6			110	11			101	100		
1R7	1.7			120	12						
1R8	1.8			130	13						
1R9	1.9			150	15						
2R0	2			160	16						
2R1	2.1			180	18						
2R2	2.2			200	20						
2R4	2.4			220	22						
2R7	2.7			240	24						
3R0	3			270	27						
3R3	3.3			300	30						
3R6	3.6			330	33						
3R9	3.9			360	36						
4R3	4.3			390	39						
4R7	4.7			430	43						
5R1	5.1			470	47						
5R6	5.6			510	51						



4.9 0709 specification capacitance table

Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)	Capac- itance code	Capac- itance (pF)	Tolerance	Max DC working voltage(V)
2R0	2	B, C, D.	500	160	16	B, C, D.	500	151	150	F, G, J.	500
2R1	2.1			180	18			161	160		
2R2	2.2			200	20			181	180		
2R4	2.4			220	22			201	200		
2R7	2.7			240	24			221	220		
3R0	3			270	27	241		240			
3R3	3.3			300	30	271		270			
3R6	3.6			330	33	301		300			
3R9	3.9			360	36						
4R3	4.3			390	39						
4R7	4.7			430	43						
5R1	5.1			470	47						
5R6	5.6			510	51						
6R2	6.2			560	56						
6R8	6.8			620	62						
7R5	7.5			680	68						
8R2	8.2			750	75						
9R1	9.1			820	82						
100	10			910	91						
120	11			101	100						
130	12			111	110						
150	13			121	120						
	15			131	130						



5. Technical requirements and test condition

5.1 General specifications

General specification GB/T 21041-2007 《Fixed capacitors for use in electronic equipment Part 21: Sectional specification: Fixed surface mount multilayer capacitors of ceramic dielectric, class 1》

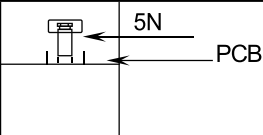
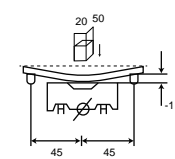
5.2 Conventional technical indicators and test method

Program	Technical specifications		Test method			
Ating temperature	(-55 ~ +125)℃					
Appearance	No obvious defects		Visual inspection			
Capacitance	Within the specification error range		Nominal capacitance	Test frequency	Test voltage	Environment
			≤1000pF	1MHz(±10%)	(1.0±0.2)Vrms	Temperature (25±2)℃ Humidity<75%
			> 1000 pF	1KHz(±10%)	(1.0±0.2)Vrms	
Quality factor (Q value)	Greater than 2000 when the frequency is 1MHz		Test method: Same as 'Capacitance'			
Loss angle tangent	Less than 0.0005 when the frequency is 1MHz					
Insulation Resistance	≥100000MΩ		Test voltage	Test time	Charge and discharge current	Environment
			Ur or 1000V, take the smaller or the two	≤60 sec	≤50mA	Temperature (25±2)℃ Humidity<75%
Dielectric Withstanding Voltage	There should be no dielectric breakdown or damage		Rated voltage	Test voltage	Time	Charge and discharge current
			Ur<200V	2.5Ur	(1~5) sec	≤50mA
			200V≤Ur≤1000V	1.5Ur		
			Ur> 1000V	1.2Ur		
Capacitance temperature coefficient or temperature characteristics	C0G: (0±30) ppm/℃		Measured after the temperature is stable for 30 minutes in the following temperature order (△C is based on T3)			
			Step	Temperature (℃)		
			T1	20±2		
			T2	-55±3		
			T3	20±2		
			T4	125±2		
			T1	20±2		
Solderability	Appearance	No visible damage, innng rate ≥95%	Immerse the capacitor in a solution of ethanol and rosin (25% by weight), take it out and preheat it at a temperature of (80~120)℃ for (10~30)sec,then immerse it in a solder solution. Soldering temperature:(235±5)℃; Soldering speed:(25±			

Note: When testing the dielectric strength of capacitors, in order to eliminate the influence of the external environment, when the test voltage exceeds 1000Vdc, the capacitor should be immersed in insulating oil for testing.



5.3 Reliability indicators and perio

Program	Technical specifications		Test method			
Resistance to soldering heat	Appearance	No visible damage,inning rate $\geq 95\% \leq$	The capacitor is immersed in a solution of ethanol and rosin(25% byweight), taken out and preheated at a temperature of 100-200°C for 10+2min, then immersed in a soldering solution. Soldering temperature:260+5°C; Soldering speed:25+0.25mm/s Soldering time: 10+1sec After being taken out, it is cleaned with a solvent and observed under a microscope with a magnification of at least 10x. The test is performed again after the capacitor has been placed in a room for 24+2hrs			
	$\Delta C/C$	$\pm 0.5\%$ or $\pm 0.5\text{pF}$,take the larger				
	D.F.	Same as the initial standard				
	I.R.	Same as the initial standard				
Terminal electrode adhesion strength	The end electrode does not peel off Appearance: no visible damage		Apply thrust: 5N Time: 10±1sec Speed: 1±0.5mm/sec			
Bending strength	Appearance	No visible damage	Test substrate: PCB board Bending depth: 1mm Application speed: 1±0.5mm/sec. Measurement should be performed bent 			
	$\Delta C/C$	$\leq \pm 5\%$				
Temperature cycling	Appearance	No visible damage	Number of cycles: 5 times, one cycle is divided into the following 4 steps:			
	$\Delta C/C$	$\leq \pm 1\%$ or $\pm 1\text{pF}$ Take the larger of the two				
	D.F.	Same as the initial standard	Step	Temperature(°C)	Time(min)	
	I.R.	Same as the initial standard	Step 1	-55±3	30	
			Step 2	20±3	3	
			Step 3	125±3	30	
		Step 4	20±3	3		
			After the test, place it at room temperature for 24±2 hrs before measuring again.			
Resistance to soldering heat	Appearance	No visible damage	Temperature: 40±2°C Humidity: 90~95%RH Time: 500+24/-0hrs After the test, place it at room temperature for 24±2 hrs before measuring again.			
	$\Delta C/C$	$\leq \pm 2\%$ or $\pm 1\text{pF}$ Take the larger of the two				
	D.F.	Same as the initial standard				
	I.R.	$R_i \geq 2500\text{M}\Omega$ or $R_i \cdot C_R > 25\text{S}$ Take the smaller of the two				
Life test	Appearance	No visible damage	Rated voltage		Applied voltage	Time
			$U_r \leq 200\text{V}$		2Ur	1000h
	$\Delta C/C$	$\leq \pm 2\%$ or $\pm 1\text{pF}$ Take the larger of the two	200V<Ur ≤500V		1.5Ur	1500h
			500V<Ur ≤1000V		1.2Ur	2000h
	D.F.	Twice the initial standard	$U_r > 1000\text{V}$		Ur	2000h
	I.R.	$R_i \geq 4000\text{M}\Omega$ or $R_i \cdot C_R > 40\text{S}$ Take the smaller of the two	Charging and discharging current : ≤ 50mA			
Temperature: (125±3)°C After the test, place it at room temperature for 24±2 hrs before measuring again.						



6. Precautions for use

1. Precautions before use

In harsh working environments or under external mechanical overpressure that exceeds the use conditions described it, first may be damaged, so when consider applying according to the relevant instructions in this approval using

2. PCB board design

2.1 The amount of solder used will affect the chip's ability to resist mechanical stress, which may cause RF-MLCC to break or crack. Therefore, when designing the substrate. the size and configuration of the pads must be carefully considered, which has a decisive effect on the amount of solder that makes up the substrate.

2.2 When designing the pads and the position of the SMD MLCC, consider reducing the stress to the lowest point and install the MLCC in the least affected position on the PC board.

3. Issues to consider for automatic installation

If the suction pipe is lowered beyond the minimum limit, it will exert excessive pressure on the MLCC and cause it to rupture. When lowering the suction pipe, pay attention to the following points:

3.1 After correcting the deviation of the PC board, adjust the lower limit of the suction pipe to the surface level of the PC board.

3.2 The suction pressure should be adjusted between iN and 3N.

3.3 In order to reduce the deformation of the PC board caused by the impact force of the suction pipe, support nails should be placed under the PC board.

4. Welding

4.1 MLCC is a combination of ceramics and metal. As a ceramic body, especially a large sized ceramic body, Its thermal plasticity is poor and its response to heat is slow, Under sudden cooling and sudden heating conditions, ceramic bodies are prone to cracking. it is recommended to preheat continuously for more than 1 minute before welding.

4.2 The interior of MLCC is a metal electrode with good thermal plasticity and fast response to heat. Therefore, Under heating conditions, there must be a certain degree of inconsistency in expansion between metal parts and ceramic parts, This will cause internal stress and easily cause ceramic body cracking. It is recommended to preheat continuously for more than 1 minute before welding.

4.3 When manual welding, use a constant temperature soldering iron with a maximum diameter of 1.0mm at the tip of its tip and a maximum power of 25 watts; do not touch MLCC components directly with a soldering iron.

4.4 It is recommended to avoid using wave soldering for specifications above 1206. 4.5 The manual welding temperature for tape/lead products should be below 350°C.

5. Cleaning

5.1 The temperature difference between components and cleaning process cannot be greater than 100°C

5.2 In case of ultrasonic cleaning, if the output power is too high, it will cause excessive vibraion on the PC board, This will cause MLCC or solder ioinis to crack or reduce terminal electrode strenoth, Therefore pav special atention to the folowing points. Ultrasonic outout: less than 20W/L: Ultrasonic frequency: less than 40KHz: Ultrasonic cleaning time: 5 minutes or less

6. Cutting PCB board

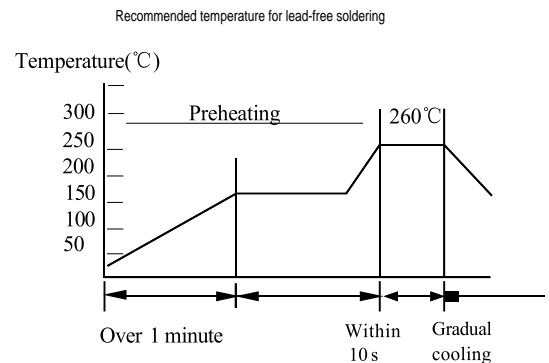
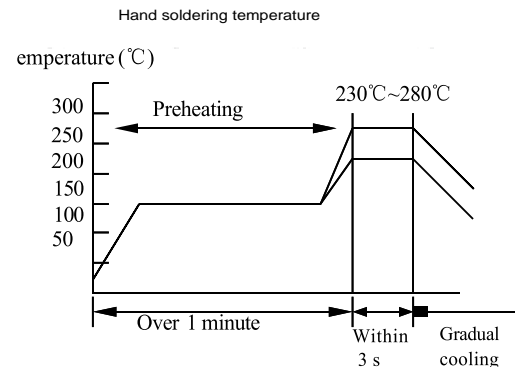
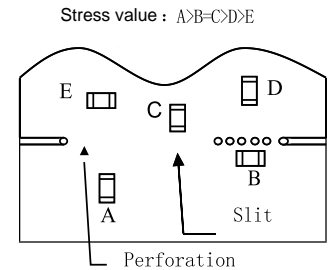
6.1 After installing MLCC and other components, when dividing PC boards, be careful not to apply any force on them. Do not let MLCC bear excessive mechanical impact.

6.2 The division of boards cannot be divided manually and should use appropriate equipment.

7. Storage method

In order to maintain terminal electrode weldability and ensure that packaging materials are in good condion, recommended storage conditions are as folows. Storage temperature: 5-40°C; Storage relave humidy: 20-70%RH Even if stored under ideal storage condions, MLcc terminal weldabiity will decrease ovel time, Therefore MLCC should be used within 6 months from date of shipment.

Soldering temperature: 260±5°C: Soldering sped: 25t0.25mms; Soldering time: 10+1 secnds, Afer being taken out, it is cleaned with a sovent and observer under a microscope with a magnificaion of at least 10x, The test is performed again afer the capacitor has been placed in a room for 24±2 hours mmersa the capacitor in a soluton of elanol and rosin 125% ov weiott. take it out and oreheat it at a temoeraure ot (80~120)°C for (10~30)sec. then immerse it in a solder solution. Soldering temperature: (235±5)°C; Soldering speed: (25±0.25)mm/sec; Soldering time: (2±0.5)sec



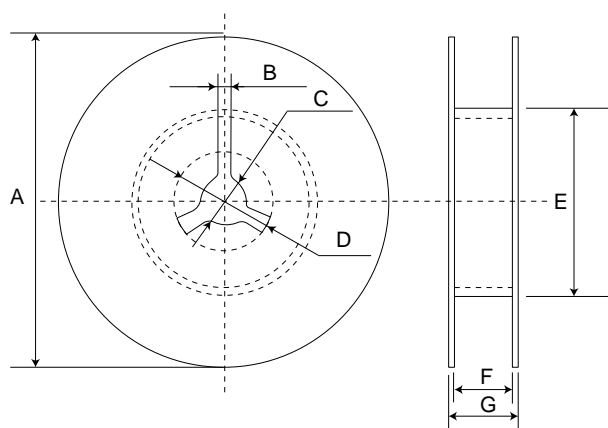
7. Product packaging

7.1 Packaging

Spec (Specification)	Qty (Quantity)	Comment
0402	10000	The packaging form and quantity can be customized
0603	4000	
0805	3000	
0505	3000	
1111	2000	

7.2 Reel dimension

Reel dimension (unit:mm)



A	B	C	D	E	F	G
Φ178.00±2.00	3.00	Φ13.00±0.50	Φ21.00±0.80	Φ50.00 or larger	10.00±1.50	12Max
Φ330.00±2.00	3.00	Φ13.00±0.50	Φ21.00±0.80	Φ50.00 or larger	10.00±1.50	12Max

7.3 Taping method

7.3.1 The tape for packaging capacitors is wound clockwise. When pulling out the tape from top to bottom, the feed hole is on the right side of the tape.

7.3.2 At the front end of the tape, at least 5 lead spacings should be left.

7.3.3 When taping, the lead part or blank part must be left as shown in the figure below.

7.3.4 The number of products installed incorrectly in the tape must be less than 0.1% or 1 per reel, and errors must not occur continuously.

7.3.5 The upper and lower adhesive tapes should not exceed the edge of the tape and should not block the feed hole. 7.6.6 The cumulative error of the feed hole is within ±0.3 mm for 10 spacings.



8. Inspection results of prohibited substances in products About R

All products meet the requirements of the RoHS directive:

- Lead(pb) (<1000ppm)
- Mercury (Hg) (<1000ppm)
- Cadmium(cd) (<100ppm)
- Hexavalent Chromium Content(Cr6+) (<1000ppm)
- Polybrominated Biphenyls(PBBs) (<1000ppm)
- Polybrominated diphenyl ethers(PBDE) (<1000ppm)